

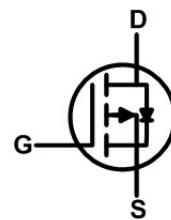
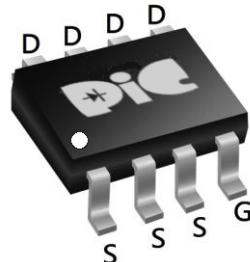
## ➤ General Description

This PAP41TJ03J P-Channel enhancement mode power field effect transistor is the high density trench technology and this advanced technology can provide excellent Rds(On) performance and efficiency for power switching and load switching application., this device also comply with the RoHS and Green Product requirement with full function reliability approved.

## ➤ Feature

- Super Low Gate Charge
- 100% EAS Guaranteed
- Green Device Available
- Excellent CdV/dt effect decline
- Advanced high cell density Trench technology

## ➤ SOP-8



## ➤ Application

- Notebook CPU Core-High-Side Switch

## ➤ Absolute Maximum Ratings

Parameter	Symbol	Rating	Units
Drain-Source Voltage	V <sub>DS</sub>	-40	V
Gate-Source Voltage	V <sub>GSS</sub>	±20	V
Continuous Drain Current, V <sub>GS</sub> @ -10V <sub>1</sub>	I <sub>D</sub> @T <sub>A</sub> =25°C	-8	A
Continuous Drain Current, V <sub>GS</sub> @ -10V <sub>1</sub>	I <sub>D</sub> @T <sub>A</sub> =70°C	-6.9	A
Pulsed Drain Current <sup>2</sup>	I <sub>DM</sub>	-32	A
Single Pulse Avalanche Energy <sup>3</sup>	EAS	41	mJ
Avalanche Current	I <sub>AS</sub>	-28.6	A
Total Power Dissipation <sup>4</sup>	P <sub>D</sub> @T <sub>A</sub> =25°C	2.5	W
Storage Temperature Range	T <sub>STG</sub>	-55 to 150	°C
Operating Junction Temperature Range	T <sub>J</sub>	-55 to 150	°C
Thermal Resistance Junction-Ambient <sup>1</sup>	R <sub>θJA</sub>	50	°C/W

➤ **Electrical Characteristics (T<sub>J</sub>=25°C Unless otherwise noted)**

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =-250uA	-40	---	---	V
BV <sub>DSS</sub> Temperature Coefficient	Δ BV <sub>DSS</sub> /Δ T <sub>J</sub>	Reference to 25°C, I <sub>D</sub> =-1mA	---	-0.02	---	V/°C
Static Drain-Source On-Resistance <sub>2</sub>	R <sub>DS(ON)</sub>	V <sub>GS</sub> =-10V, I <sub>D</sub> =-5A	---	---	32	mΩ
		V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-4A	---	---	46	
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =-250uA	-1.2	---	-2.5	V
V <sub>GS(th)</sub> Temperature Coefficient	Δ V <sub>GS(th)</sub>		---	3.72	---	V/°C
Drain-Source Leakage Current	I <sub>DSS</sub>	V <sub>DS</sub> =-32V, V <sub>GS</sub> =0V, T <sub>J</sub> =25°C	---	---	-1	uA
		V <sub>DS</sub> =-32V, V <sub>GS</sub> =0V, T <sub>J</sub> =55°C	---	---	-5	
Gate-Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V	---	---	±100	nA
Forward Transconductance	g <sub>f</sub>	V <sub>DS</sub> =-5V, I <sub>D</sub> =-8A	---	10.7	---	S
Total Gate Charge (-4.5V)	Q <sub>g</sub>	V <sub>DS</sub> =-15V, V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-1A	---	11.5	---	nC
Gate-Source Charge	Q <sub>gs</sub>		---	3.5	---	
Gate-Drain Charge	Q <sub>gd</sub>		---	3.3	---	
Turn-On Delay Time	T <sub>d(on)</sub>	V <sub>DD</sub> =-15V, V <sub>GS</sub> =-10V, R <sub>G</sub> =3.3Ω, I <sub>D</sub> =-1A	---	22	---	ns
Rise Time	T <sub>r</sub>		---	15.7	---	
Turn-Off Delay Time	T <sub>d(off)</sub>		---	59	---	
Fall Time	T <sub>f</sub>		---	5.5	---	
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =-15V, V <sub>GS</sub> =0V, f=1MHz	---	1415	---	pF
Output Capacitance	C <sub>oss</sub>		---	134	---	
Reverse Transfer Capacitance	C <sub>rss</sub>		---	102	---	

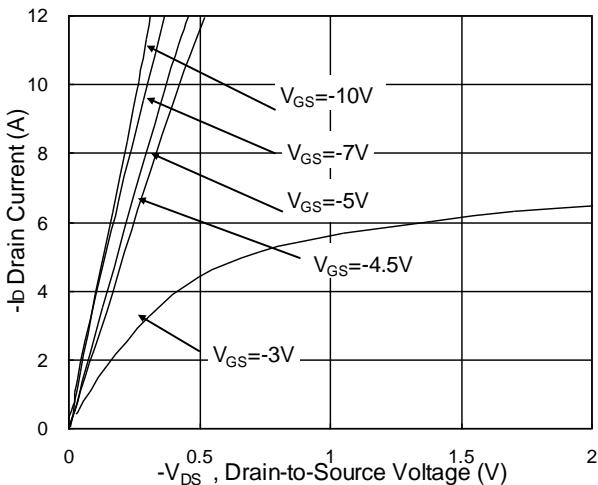
➤ **Diode Characteristics**

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Continuous Source Current <sub>1,5</sub>	I <sub>s</sub>	V <sub>G</sub> =V <sub>D</sub> =0V, Force Current	---	---	-8	A
Diode Forward Voltage <sub>2</sub>	V <sub>SD</sub>	V <sub>GS</sub> =0V, I <sub>s</sub> =-1A, T <sub>J</sub> =25°C	---	---	-1.2	V

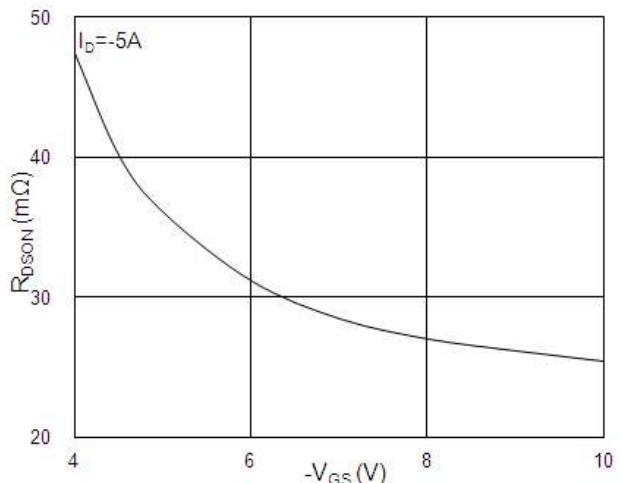
Note :

- 1.Pulse width limited by maximum junction temperature.
- 2.The data tested by pulsed , pulse width ≤ 300us , duty cycle ≤ 2%
- 3.The EAS data shows Max. rating . The test condition is V<sub>DD</sub>=-25V,V<sub>GS</sub>=-10V,L=0.1mH,I<sub>AS</sub>=-28.6A
- 4.Ensure that the channel temperature does not exceed 150°C.
- 5.The data is theoretically the same as ID and IDM , in real applications , should be limited by total power dissipation.

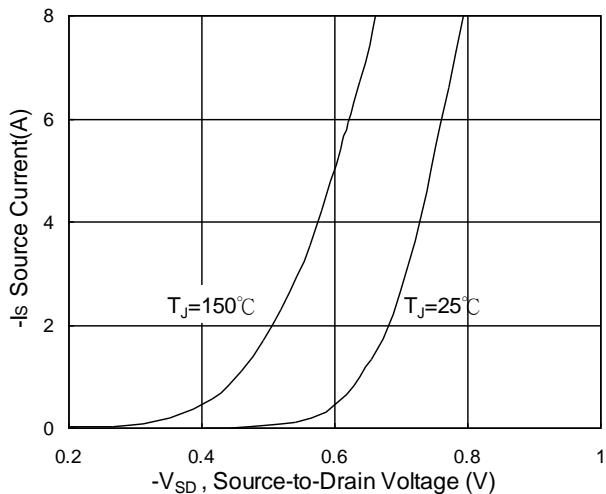
## ➤ Typical Characteristics



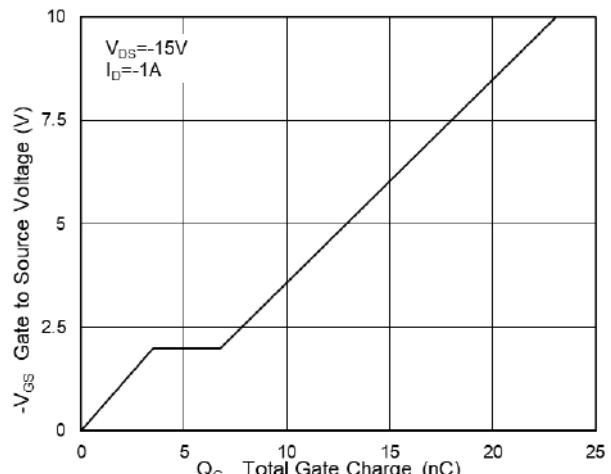
**Fig.1 Typical Output Characteristics**



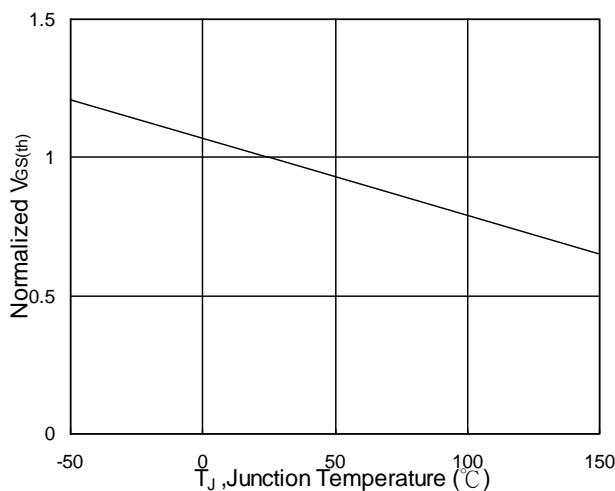
**Fig.2 On-Resistance vs G-S Voltage**



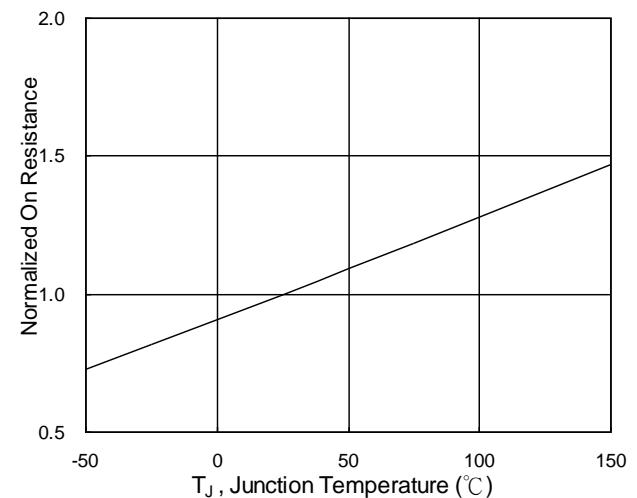
**Fig.3 Source Drain Forward Characteristics**



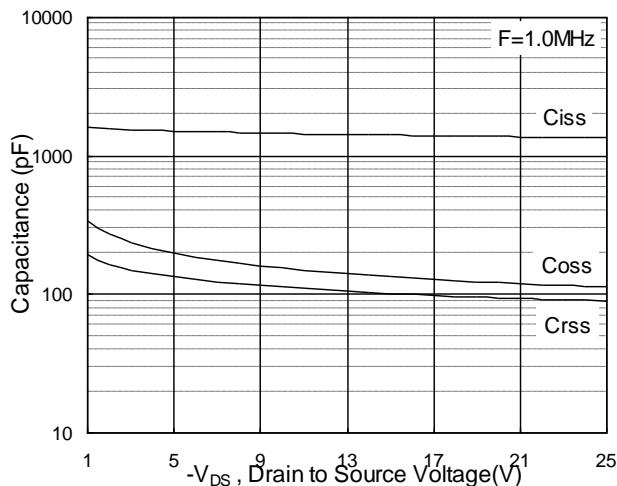
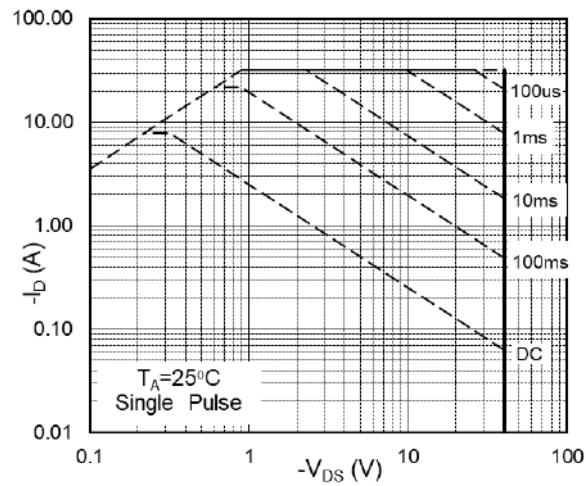
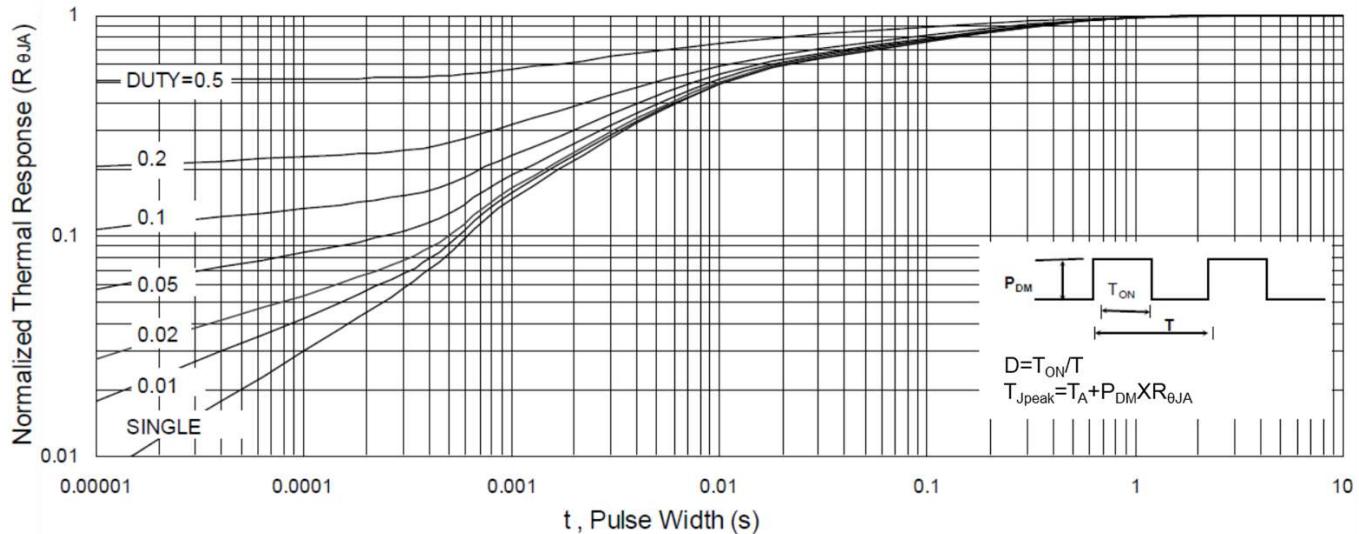
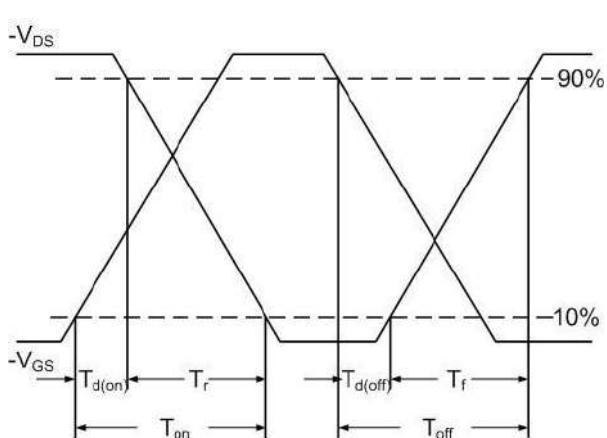
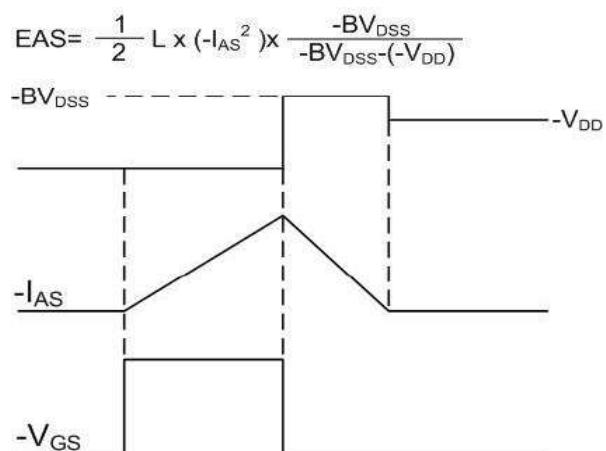
**Fig.4 Gate Charge Characteristics**

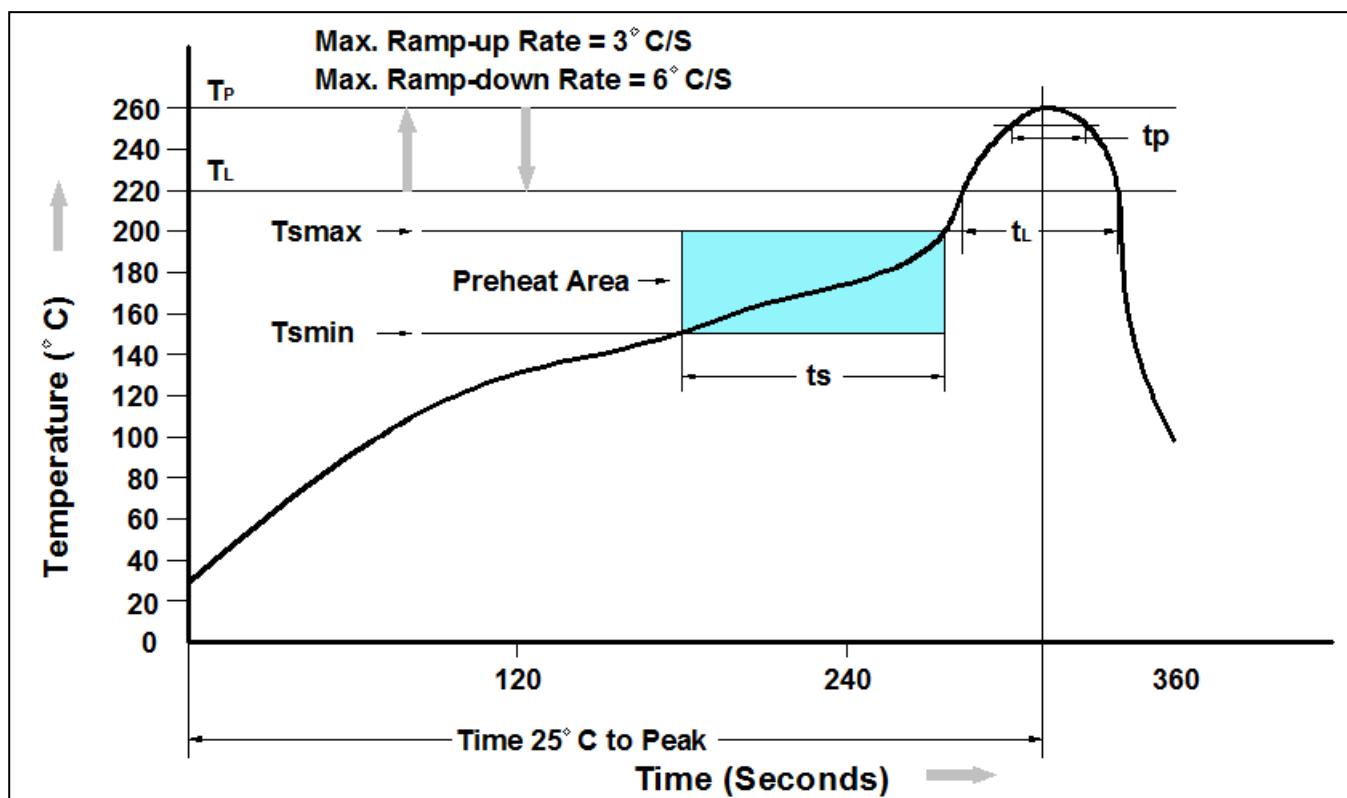


**Fig.5 Normalized  $V_{GS(th)}$  vs  $T_J$**



**Fig.6 Normalized  $R_{DS(on)}$  vs  $T_J$**


**Fig.7 Capacitance**

**Fig.8 Safe Operating Area**

**Fig.9 Normalized Maximum Transient Thermal Impedance**

**Fig.10 Switching Time Waveform**

**Fig.11 Unclamped Inductive Switching Waveform**

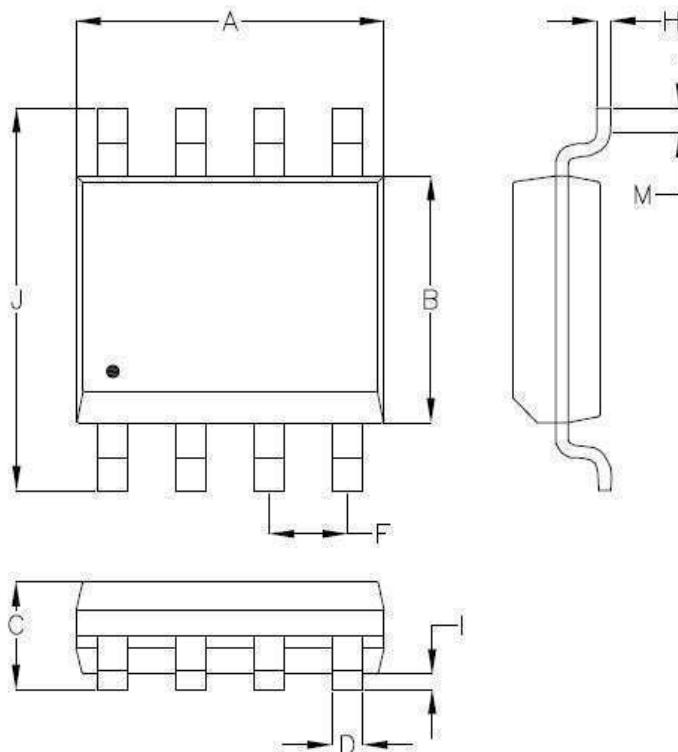
➤ Recommand IR Reflow Soldering Thermal Profile


Profile Feature	Pb-Free Assembly Profile
Temperature Min. (T <sub>smin</sub> )	150°C
Temperature Max. (T <sub>smax</sub> )	200°C
Time (t <sub>s</sub> ) from (T <sub>smin</sub> to T <sub>smax</sub> )	60-120 seconds
Average Ramp-up Rate (t <sub>L</sub> to t <sub>P</sub> )	3°C/second max.
Liquidous Temperature (T <sub>L</sub> )	217°C
Time (t <sub>L</sub> ) Maintained Above (T <sub>L</sub> )	60 – 150 seconds
Peak Temperature	260°C +0°C / -5°C
Time (t <sub>P</sub> ) within 5°C of actual Peak Temperature	30 seconds
Ramp-down Rate (T <sub>P</sub> to T <sub>L</sub> )	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.

➤ Ordering Information

Part Number	Description	Quantity
PAP41TJ03J	SOP-8 Reel	2500 pcs

➤ **Package Information (SOP-8)**



SYMBOLS	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.700	5.150	0.185	0.203
B	3.700	4.100	0.146	0.161
C	1.23	1.753	0.048	0.069
D	0.310	0.510	0.012	0.020
F	1.070	1.470	0.042	0.058
H	0.160	0.254	0.006	0.010
I	0.050	0.254	0.002	0.010
J	5.750	6.250	0.226	0.246
M	0.400	1.270	0.016	0.050

## **DISCLAIMER**

- The information in this document and any product described herein are subject to change without notice and should not be construed as a commitment by Paceleader, Paceleader reserve the right to make changes to the information in this document.
- Though Paceleader make effort to improve product quality and reliability, Product can malfunction and fail due to their inherent electrical sensitivity and vulnerability to physical stress, it is the responsibility of the customer, when utilizing Paceleader products, to comply with the standards of safety in making a safe design for entire system and to avoid situation in which a malfunction or failure., In developing a new designs, customer should ensure that the device which shown in this documents are used within specified operating ranges.
- The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by Paceleader for any infringements of patents or other rights of the third parties which may result from its use.